

## Features

- Planar Die Construction
- General Purpose Medium Current
- Ideally Suited for Automated Assembly Processes
- Halogen Free. "Green" Device (Note 1)
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

**500 mW  
Zener Diode  
2.0 to 75 Volts**

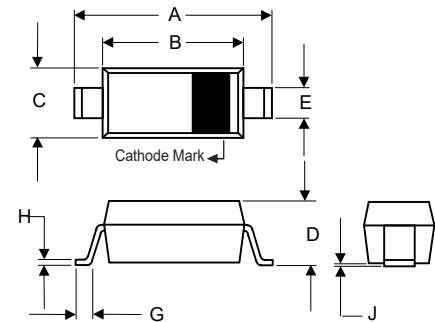
## Maximum Ratings

- Operating Junction Temperature Range: -65°C to +150°C
- Storage Temperature Range: -65°C to +150°C
- Thermal Resistance : 250°C/W Junction to Ambient

Parameter	Symbol	Rating	Conditions
Power Dissipation	$P_D$	500mW	
Maximum Forward Voltage	$V_F$	0.9V	$I_F=10mA$

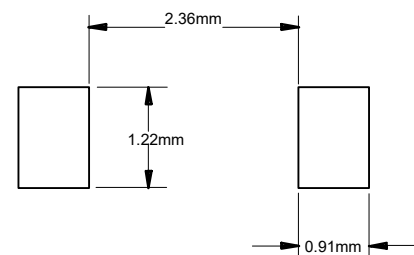
Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

## SOD-123



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.140	0.152	3.55	3.85	
B	0.100	0.112	2.55	2.85	
C	0.055	0.067	1.40	1.70	
D	----	0.053	----	1.35	
E	0.018	0.026	0.45	0.65	
G	0.006	0.018	0.15	0.45	
H	----	0.010	----	0.25	
J	----	0.006	----	0.15	

## SUGGESTED SOLDER PAD LAYOUT



**Electrical Characteristics @ 25°C Unless Otherwise Specified**

MCC Part Number	Zener Voltage			Maximum Zener Impedance <sup>(2)</sup>		Maximum Zener Impedance <sup>(2)</sup>		Maximum Reverse Current I <sub>R</sub> (Max) @ V <sub>R</sub>		Typical Temperature Coefficient @ I <sub>ZTC</sub>		Marking Code
	V <sub>Z</sub> @ I <sub>ZT</sub>			I <sub>ZT</sub>	Z <sub>ZT</sub> @ I <sub>ZT</sub>	I <sub>ZK</sub>	Z <sub>ZK</sub> @ I <sub>ZK</sub>	I <sub>R</sub>	V <sub>R</sub>	mV/°C		
	Min.(V)	Nom(V)	Max.(V)	mA	Ω	mA	Ω	μA	V	Min	Max.	
BZT52C2V0	1.9	2.0	2.1	5	100	1.0	600	90	1.0	-3.5	0	WY
BZT52C2V4	2.28	2.4	2.56	5	100	1.0	600	50	1.0	-3.5	0	WX
BZT52C2V7	2.5	2.7	2.9	5	100	1.0	600	20	1.0	-3.5	0	W1
BZT52C3V0	2.8	3.0	3.2	5	95	1.0	600	10	1.0	-3.5	0	W2
BZT52C3V3	3.1	3.3	3.5	5	95	1.0	600	5	1.0	-3.5	0	W3
BZT52C3V6	3.4	3.6	3.8	5	90	1.0	600	5	1.0	-3.5	0	W4
BZT52C3V9	3.7	3.9	4.1	5	90	1.0	600	3	1.0	-3.5	0	W5
BZT52C4V3	4.0	4.3	4.6	5	90	1.0	600	3	1.0	-3.5	0	W6
BZT52C4V7	4.4	4.7	5.0	5	80	1.0	500	3	2.0	-3.5	0.2	W7
BZT52C5V1	4.8	5.1	5.4	5	60	1.0	480	2	2.0	-2.7	1.2	W8
BZT52C5V6	5.2	5.6	6.0	5	40	1.0	400	1	2.0	-2.0	2.5	W9
BZT52C6V2	5.8	6.2	6.6	5	10	1.0	150	3	4.0	0.4	3.7	WA
BZT52C6V8	6.4	6.8	7.2	5	15	1.0	80	2	4.0	1.2	4.5	WB
BZT52C7V5	7.0	7.5	7.9	5	15	1.0	80	1	5.0	2.5	5.3	WC
BZT52C8V2	7.7	8.2	8.7	5	15	1.0	80	0.7	5.0	3.2	6.2	WD
BZT52C9V1	8.5	9.1	9.6	5	15	1.0	100	0.5	6.0	3.8	7.0	WE
BZT52C10	9.4	10	10.6	5	20	1.0	150	0.2	7.0	4.5	8.0	WF
BZT52C11	10.4	11	11.6	5	20	1.0	150	0.1	8.0	5.4	9.0	WG
BZT52C12	11.4	12	12.7	5	25	1.0	150	0.1	8.0	6.0	10.0	WH
BZT52C13	12.4	13	14.1	5	30	1.0	170	0.1	8.0	7.0	11.0	WI
BZT52C15	13.8	15	15.6	5	30	1.0	200	0.1	10.5	9.2	13.0	WJ
BZT52C16	15.3	16	17.1	5	40	1.0	200	0.1	11.2	10.4	14.0	WK
BZT52C18	16.8	18	19.1	5	45	1.0	225	0.1	12.6	12.4	16.0	WL
BZT52C20	18.8	20	21.2	5	55	1.0	225	0.1	14.0	14.4	18.0	WM
BZT52C22	20.8	22	23.3	5	55	1.0	250	0.1	15.4	16.4	20.0	WN
BZT52C24	22.8	24	25.6	5	70	1.0	250	0.1	16.8	18.4	22.0	WO
BZT52C27	25.1	27	28.9	2	80	0.5	300	0.1	18.9	21.4	25.3	WP
BZT52C30	28	30	32	2	80	0.5	300	0.1	21.0	24.4	29.4	WQ
BZT52C33	31	33	35	2	80	0.5	325	0.1	23.1	27.4	33.4	WR
BZT52C36	34	36	38	2	90	0.5	350	0.1	25.2	30.4	37.4	WS
BZT52C39	37	39	41	2	130	0.5	350	0.1	27.3	33.4	41.2	WT
BZT52C43	40	43	46	5	100	1.0	700	0.1	32.0	10.0	12.0	WU
BZT52C47	44	47	50	5	100	1	750	0.1	35	10	12	WV
BZT52C51	48	51	54	5	100	1	750	0.1	38	10	12	WW
BZT52C56	53	56	59	2	200	1	1000	0.1	42	33.4	41.2	X1
BZT52C62	59	62	65	2	150	1	1000	0.1	46	10	12	5X2
BZT52C68	64.6	68	71.4	2	200	1	1000	0.1	51	10	12	5X3
BZT52C75	71	75	79	2	250	1	1000	0.1	56	10	12	5X4

Note : 2. f=1KHz

**Curve Characteristics**

Fig. 1 - Power Derating Curve

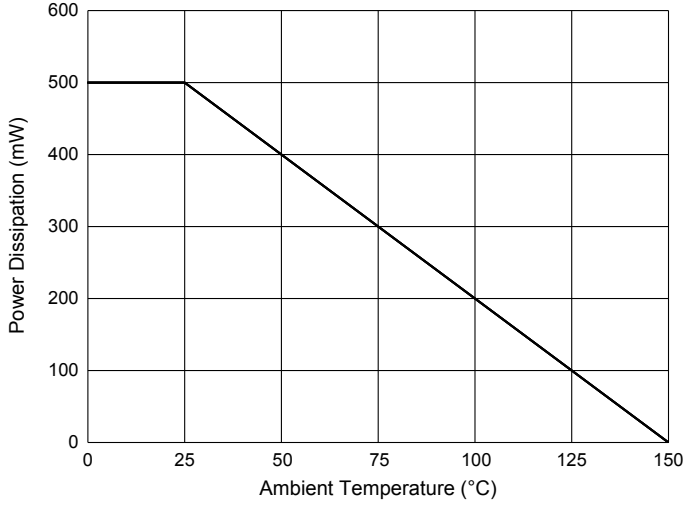


Fig. 2 - Typical Zener Breakdown Characteristics

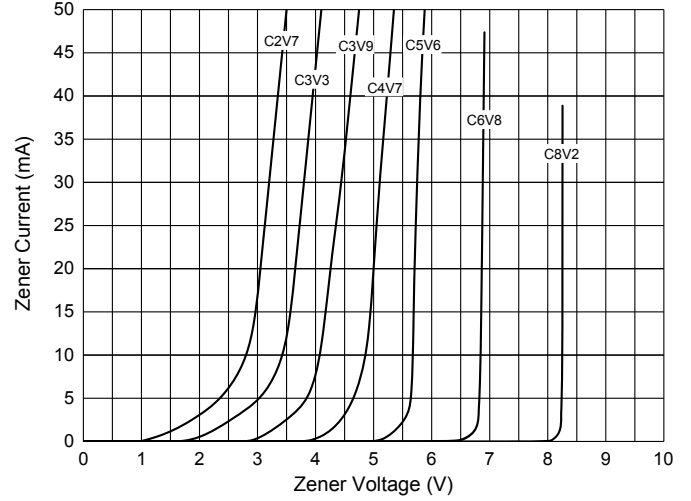


Fig. 3 - Typical Zener Breakdown Characteristics

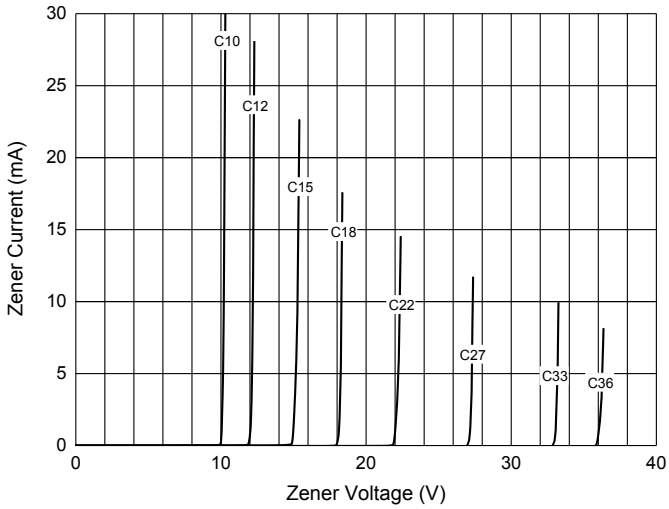
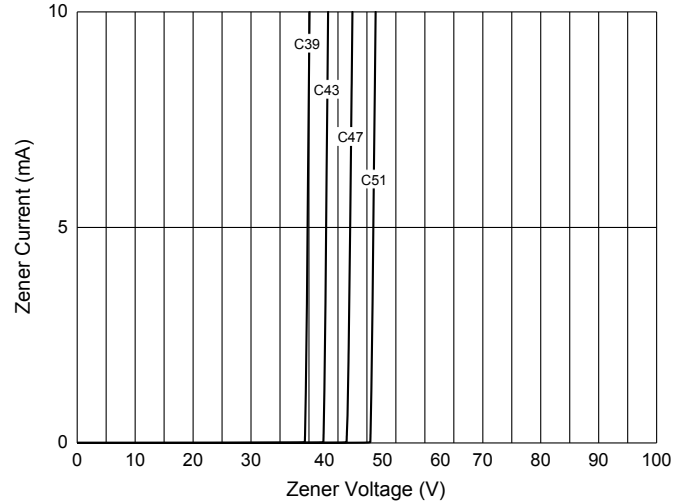


Fig. 4 - Typical Zener Breakdown Characteristics



## Ordering Information

Device	Packing
Part Number-TP	Tape&Reel:3Kpcs/Reel

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